

TriLEC PC23ESD (U)

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General Information		
luct Description		
Electrostatic dissipative PC, impac	t modified.	
FEATURES	ADDITIONAL FORMULAS	COLOR
-Good Strength	-Additional UV "U"	-All
-EMI/ESD/RFI	-(C, AS) grades also available.	-Opaque
-Medium Flow		2
eral		
Typical Applications	-Transportation, defense, packaging, enclosures	
Processing Method	-Injection/Extrusion	
Form(s)	-Pellets	
Availability	-North America, Europe, Asia, Latin America	
	ASTM / ISO Properties ¹	
sical	Nominal Value U	nit Test Method
Density	1.28 g/	/cm ³ ASTM D792
Melt Flow Rate (350°C/1.2kg)	14 g/	/10min ASTM D1238
Molding Shrinkage - Flow (3.2	mm) 0.2 to 0.4 %	TVT Internal
Outdoor Suitability (QUV) ("U"	Grades) Pass	TVT Internal
nanical	Nominal Value U	nit Test Method
Tensile Strength, yld	7000 ps	si ASTM D638
Tensile Elongation, yld	>2 %	ASTM D638
Flexural Modulus	510,000 ps	si ASTM D790
Unnotched Izod Impact (73F)	6 ft-	lbs/in ASTM D256
trical	Nominal Value U	nit Test Method
Surface Resistivity	1 x 10 ⁶ - 1x 10 ¹¹ Ω	/cm ³ ASTM D257
mability	Nominal Value U	nit Test Method
0.06 in	HB	UL94 - TVT Interna
ommended Processing Guida	100	
Drying Temperature	240 to 260 °F	
Drying Time	2 to 4 H	ours
Suggested Max Moisture	0.02 %	
Processing Melt Temperature	550 to 590 °F	:
Mold Temperature	160 to 240 °F	

Note: The values listed on this guide are typical values based on general molding conditions and used solely for the purpose of general material processing. It is recommended that application properties be derived from actual molded articles, whereas properties as molded could vary. These are not to be used as specifications. This data does not provide an implied conditional warranty.